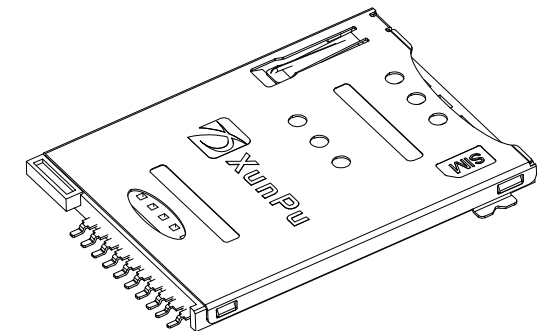


MATERIAL: INSULATOR: HIGH TEMPERATURE THERMOPLASTIC,
UL 94V-0.COLOR"BLACK LCP
CONTACT: COPPER ALLOY
PLATING:
CONTACT: PLATED 30U" NI OVERALL
PLATED AU SELECTIVE CONTACT AREA
SHELL: PLATED 30U" NI OVERALL,PAD G/F AU
ELECTRICAL:
CURRENT RATING: 0.5AMPS
VOLTAGE RATING: 5V AC/DC
AMBIENT TEMPERATURE RANGE: -20°C~+60°C
STORAGE TEMPERATURE RANGE: -40°C~+80°C
AMBIENT HUMIDITY RANGE: 95% R.H. MAX.
CONTACT RESISTANCE: 100MΩMAX.
INSULATION RESISTANCE: 1000MΩMIN./500VDC
MATING CYCLES: 5,000 INSERTIONS
REFLOW PEAK TEMP: 260°C

MINI SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A
SW1	DETECTION SWITCH
SW2	DETECTION SWITCH



MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd			
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: MINI SIM CARD PUSH PUSH: 8+2P SMT无铅		
			PAR	SIM-118	
DWN	YAO				
CHKD					
APVD					
DECIMALS:	ANGLES: ±1°	SCALE: 1:1	UNIT: MM		
X.X: ±0.25		CUSTOMER COPY	SIZE: A4	SHEET: 1F1	REV: A
X.XX: ±0.10					
X.XXX: ±0.05					